

International **IR** Rectifier

INSULATED GATE BIPOLEAR TRANSISTOR WITH ULTRAFAST SOFT RECOVERY DIODE

Features

- Optimized for use in Welding and Switch-Mode Power Supply applications
- Industry benchmark switching losses improve efficiency of all power supply topologies
- 50% reduction of Eoff parameter
- Low IGBT conduction losses
- Latest technology IGBT design offers tighter parameter distribution coupled with exceptional reliability
- IGBT co-packaged with HEXFRED™ ultrafast, ultra-soft-recovery anti-parallel diodes for use in bridge configurations
- Industry standard TO-247AC package

Benefits

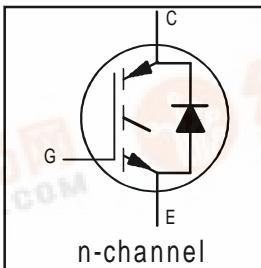
- Lower switching losses allow more cost-effective operation and hence efficient replacement of larger-die MOSFETs up to 100kHz
- HEXFRED™ diodes optimized for performance with IGBTs. Minimized recovery characteristics reduce noise, EMI and switching losses

Absolute Maximum Ratings

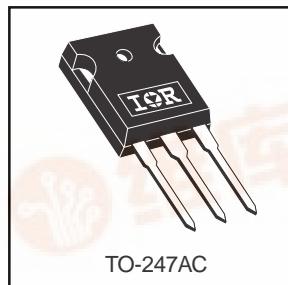
	Parameter	Max.	Units
V_{CES}	Collector-to-Emitter Breakdown Voltage	900	V
$I_c @ T_c = 25^\circ C$	Continuous Collector Current	51	A
$I_c @ T_c = 100^\circ C$	Continuous Collector Current	28	
I_{CM}	Pulsed Collector Current ①	204	
I_{LM}	Clamped Inductive Load Current ②	204	
$I_F @ T_c = 100^\circ C$	Diode Continuous Forward Current	16	V
I_{FM}	Diode Maximum Forward Current	204	
V_{GE}	Gate-to-Emitter Voltage	± 20	
$P_D @ T_c = 25^\circ C$	Maximum Power Dissipation	200	W
$P_D @ T_c = 100^\circ C$	Maximum Power Dissipation	78	
T_J T_{STG}	Operating Junction and Storage Temperature Range	-55 to + 150	°C
	Soldering Temperature, for 10 seconds	300 (0.063 in. (1.6mm) from case)	
	Mounting torque, 6-32 or M3 screw.	10 lbf·in (1.1N·m)	

Thermal Resistance

	Parameter	Min.	Typ.	Max.	Units
R_{JC}	Junction-to-Case - IGBT	—	—	0.64	°C/W
R_{JDC}	Junction-to-Case - Diode	—	—	0.83	
R_{CS}	Case-to-Sink, flat, greased surface	—	0.24	—	
R_{RA}	Junction-to-Ambient, typical socket mount	—	—	40	
W_t	Weight	—	6 (0.21)	—	g (oz)



$V_{CES} = 900V$
 $V_{CE(on)} \text{ typ.} = 2.25V$
 $@ V_{GE} = 15V, I_C = 28A$



IRG4PF50WD

International
IR Rectifier

Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Conditions
$V_{(\text{BR})\text{CES}}$	Collector-to-Emitter Breakdown Voltage ^③	900	—	—	V	$V_{\text{GE}} = 0\text{V}$, $I_C = 250\mu\text{A}$
$\Delta V_{(\text{BR})\text{CES}/\Delta T_J}$	Temperature Coeff. of Breakdown Voltage	—	0.295	—	V/ $^\circ\text{C}$	$V_{\text{GE}} = 0\text{V}$, $I_C = 3.5\text{mA}$
$V_{\text{CE}(\text{on})}$	Collector-to-Emitter Saturation Voltage	—	2.25	2.7	V	$I_C = 28\text{A}$ $V_{\text{GE}} = 15\text{V}$
		—	2.74	—		$I_C = 60\text{A}$ See Fig. 2, 5
		—	2.12	—		$I_C = 28\text{A}$, $T_J = 150^\circ\text{C}$
$V_{\text{GE}(\text{th})}$	Gate Threshold Voltage	3.0	—	6.0		$V_{\text{CE}} = V_{\text{GE}}$, $I_C = 250\mu\text{A}$
$\Delta V_{\text{GE}(\text{th})/\Delta T_J}$	Temperature Coeff. of Threshold Voltage	—	-13	—	mV/ $^\circ\text{C}$	$V_{\text{CE}} = V_{\text{GE}}$, $I_C = 250\mu\text{A}$
g_{fe}	Forward Transconductance ^④	26	39	—	S	$V_{\text{CE}} = 50\text{V}$, $I_C = 28\text{A}$
I_{CES}	Zero Gate Voltage Collector Current	—	—	500	μA	$V_{\text{GE}} = 0\text{V}$, $V_{\text{CE}} = 900\text{V}$
		—	—	2.0		$V_{\text{GE}} = 0\text{V}$, $V_{\text{CE}} = 10\text{V}$, $T_J = 25^\circ\text{C}$
		—	—	6.5	mA	$V_{\text{GE}} = 0\text{V}$, $V_{\text{CE}} = 900\text{V}$, $T_J = 150^\circ\text{C}$
V_{FM}	Diode Forward Voltage Drop	—	2.5	3.5	V	$I_C = 16\text{A}$ See Fig. 13
		—	2.1	3.0		$I_C = 16\text{A}$, $T_J = 150^\circ\text{C}$
I_{GES}	Gate-to-Emitter Leakage Current	—	—	± 100	nA	$V_{\text{GE}} = \pm 20\text{V}$

Switching Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Conditions
Q_g	Total Gate Charge (turn-on)	—	160	240	nC	$I_C = 28\text{A}$
Q_{ge}	Gate - Emitter Charge (turn-on)	—	19	29		$V_{\text{CC}} = 400\text{V}$ See Fig. 8
Q_{gc}	Gate - Collector Charge (turn-on)	—	53	80		$V_{\text{GE}} = 15\text{V}$
$t_{\text{d}(\text{on})}$	Turn-On Delay Time	—	71	—	ns	$T_J = 25^\circ\text{C}$
t_r	Rise Time	—	50	—		$I_C = 28\text{A}$, $V_{\text{CC}} = 720\text{V}$
$t_{\text{d}(\text{off})}$	Turn-Off Delay Time	—	150	220		$V_{\text{GE}} = 15\text{V}$, $R_G = 5.0\Omega$
t_f	Fall Time	—	110	170		Energy losses include "tail" and diode reverse recovery. See Fig. 9, 10, 18
E_{on}	Turn-On Switching Loss	—	2.63	—	mJ	
E_{off}	Turn-Off Switching Loss	—	1.34	—		
E_{ts}	Total Switching Loss	—	3.97	5.3		
$t_{\text{d}(\text{on})}$	Turn-On Delay Time	—	69	—	ns	$T_J = 150^\circ\text{C}$, See Fig. 11, 18
t_r	Rise Time	—	52	—		$I_C = 28\text{A}$, $V_{\text{CC}} = 720\text{V}$
$t_{\text{d}(\text{off})}$	Turn-Off Delay Time	—	270	—		$V_{\text{GE}} = 15\text{V}$, $R_G = 5.0\Omega$
t_f	Fall Time	—	190	—		Energy losses include "tail" and diode reverse recovery. See Fig. 9, 10, 18
E_{ts}	Total Switching Loss	—	6.0	—	mJ	
L_E	Internal Emitter Inductance	—	13	—		Measured 5mm from package
C_{ies}	Input Capacitance	—	3300	—		
C_{oes}	Output Capacitance	—	200	—	pF	$V_{\text{GE}} = 0\text{V}$
C_{res}	Reverse Transfer Capacitance	—	45	—		$V_{\text{CC}} = 30\text{V}$ See Fig. 7
$f = 1.0\text{MHz}$						
t_{rr}	Diode Reverse Recovery Time	—	90	135	ns	$T_J = 25^\circ\text{C}$ See Fig.
		—	164	245		$T_J = 125^\circ\text{C}$ 14
I_{rr}	Diode Peak Reverse Recovery Current	—	5.8	10	A	$T_J = 25^\circ\text{C}$ See Fig.
		—	8.3	15		$T_J = 125^\circ\text{C}$ 15
Q_{rr}	Diode Reverse Recovery Charge	—	260	675	nC	$T_J = 25^\circ\text{C}$ See Fig.
		—	680	1838		$T_J = 125^\circ\text{C}$ 16
$dI_{(\text{rec})\text{M}/dt}$	Diode Peak Rate of Fall of Recovery During t_f	—	120	—	A/ μs	$T_J = 25^\circ\text{C}$ See Fig.
		—	76	—		$T_J = 125^\circ\text{C}$ 17

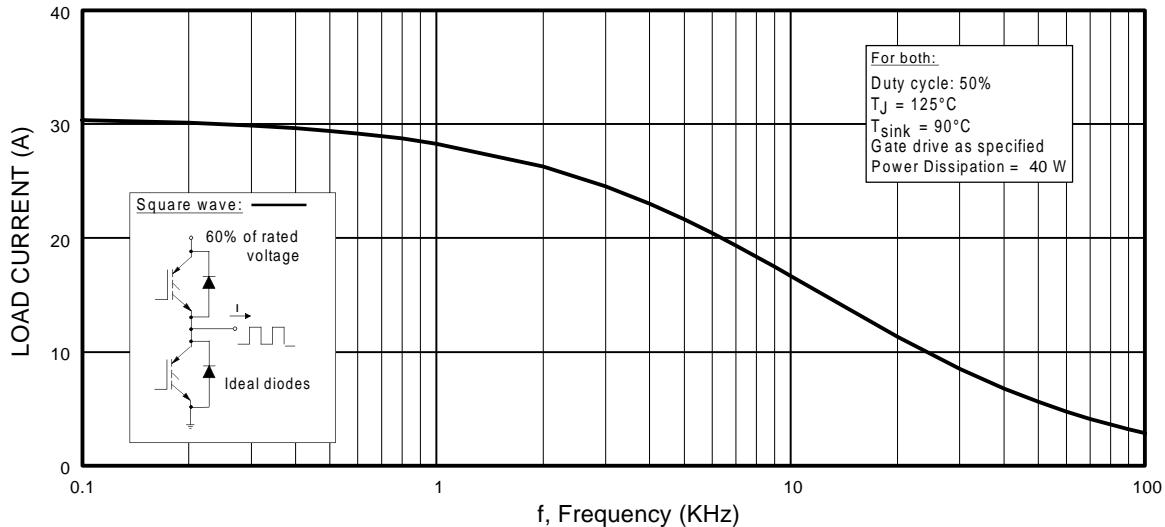


Fig. 1 - Typical Load Current vs. Frequency
 (Load Current = I_{RMS} of fundamental)

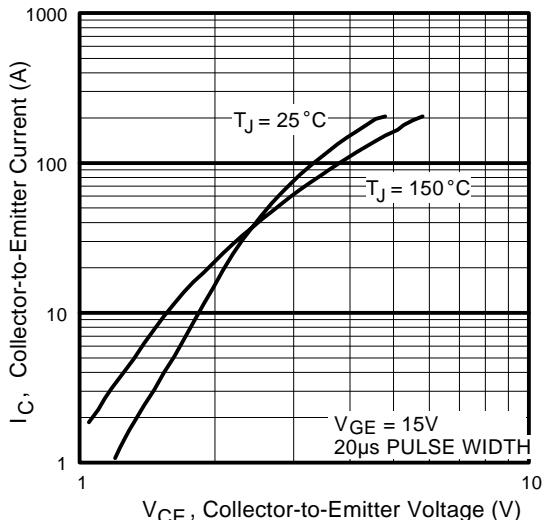


Fig. 2 - Typical Output Characteristics

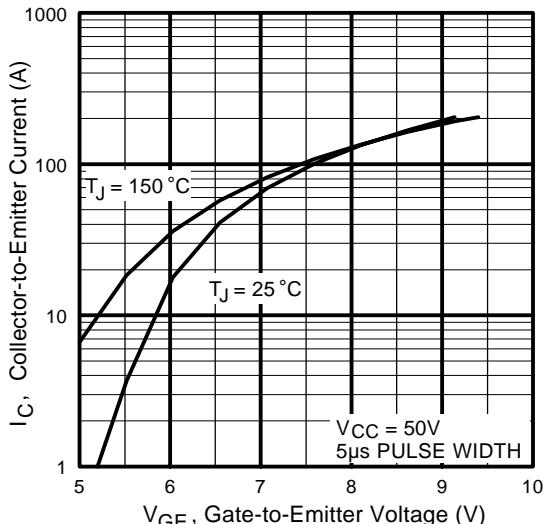


Fig. 3 - Typical Transfer Characteristics

IRG4PF50WD

International
IR Rectifier

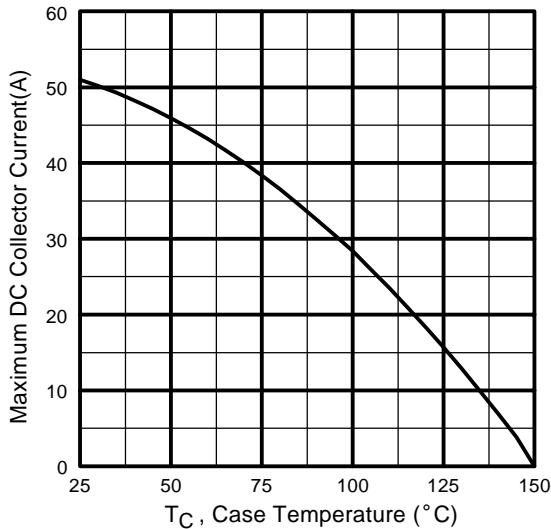


Fig. 4 - Maximum Collector Current vs. Case Temperature

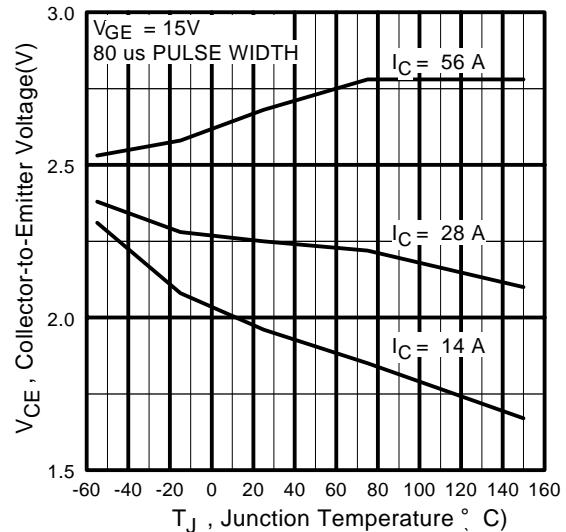


Fig. 5 - Collector-to-Emitter Voltage vs. Junction Temperature

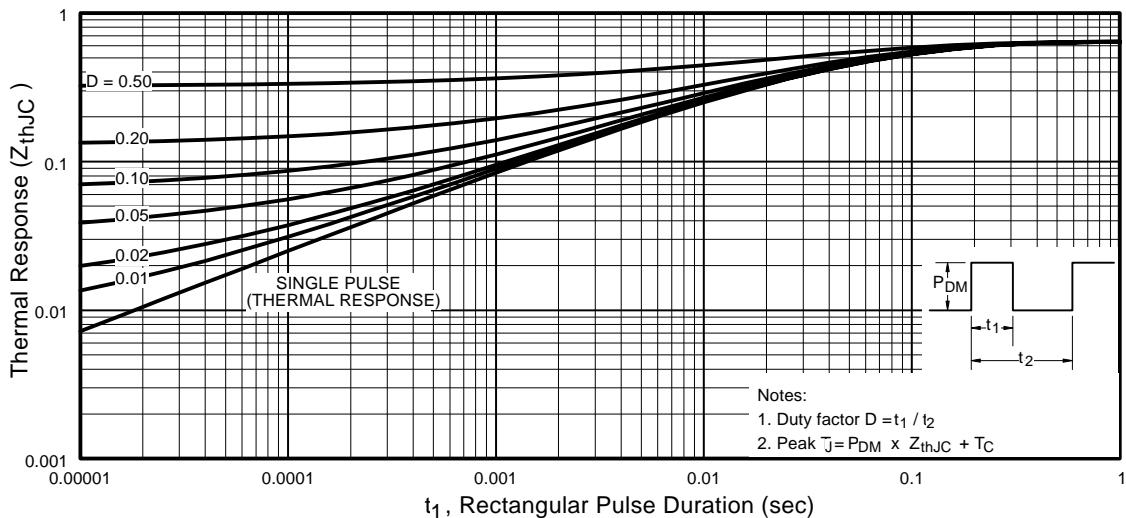
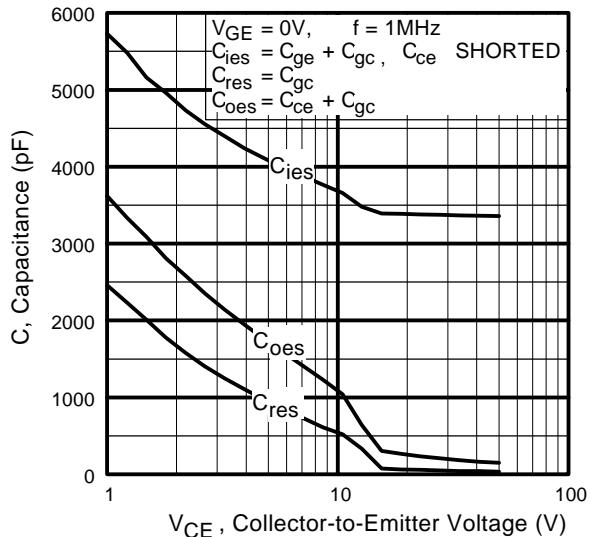
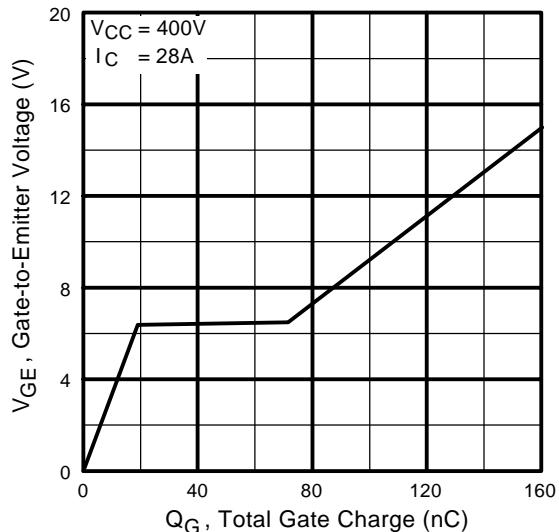


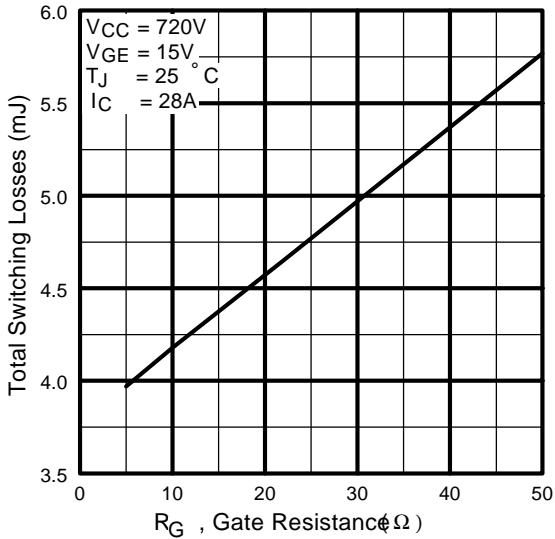
Fig. 6 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



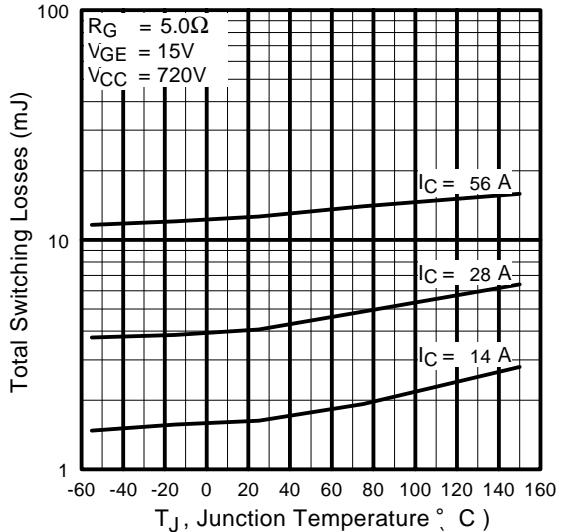
**Fig. 7 - Typical Capacitance vs.
 Collector-to-Emitter Voltage**



**Fig. 8 - Typical Gate Charge vs.
 Gate-to-Emitter Voltage**



**Fig. 9 - Typical Switching Losses vs. Gate
 Resistance**



**Fig. 10 - Typical Switching Losses vs.
 Junction Temperature**

IRG4PF50WD

International
IR Rectifier

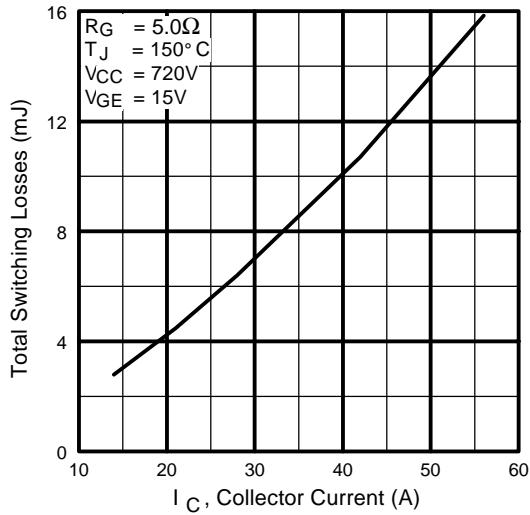


Fig. 11 - Typical Switching Losses vs.
Collector-to-Emitter Current

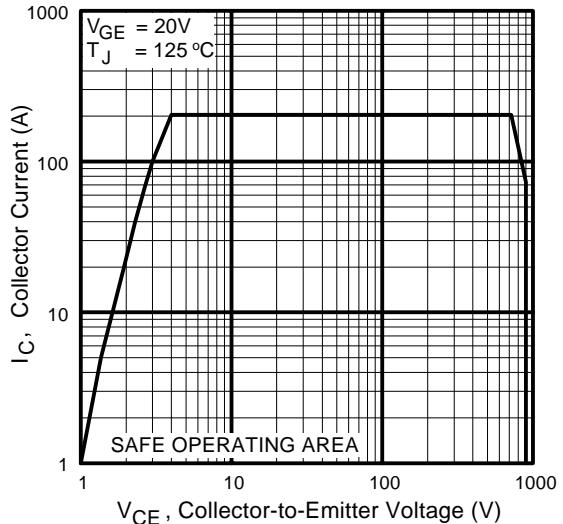


Fig. 12 - Turn-Off SOA

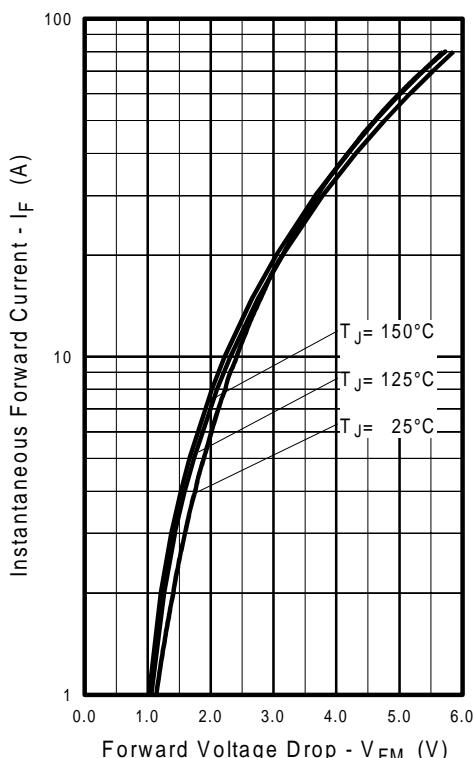


Fig. 13 - Typical Forward Voltage Drop vs. Instantaneous Forward Current

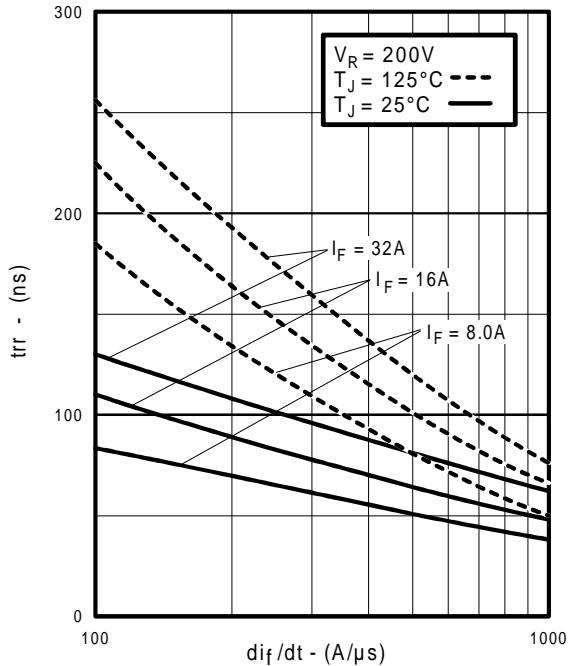


Fig. 14 - Typical Reverse Recovery vs. di_f/dt

IRG4PF50WD

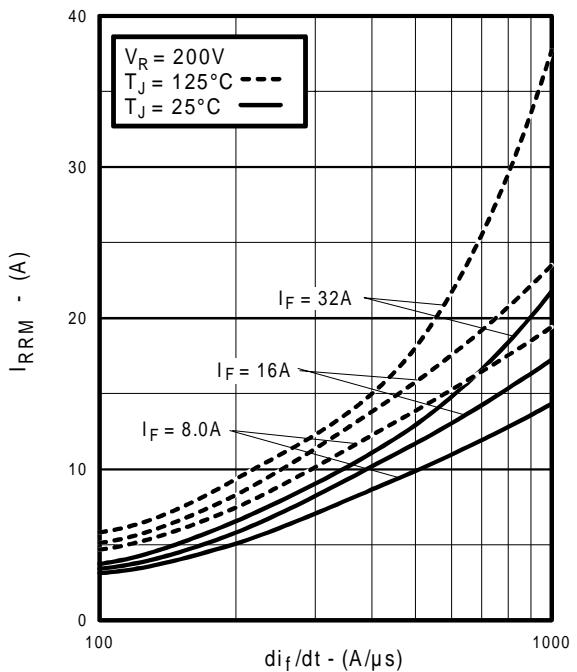


Fig. 15 - Typical Recovery Current vs. di_f/dt

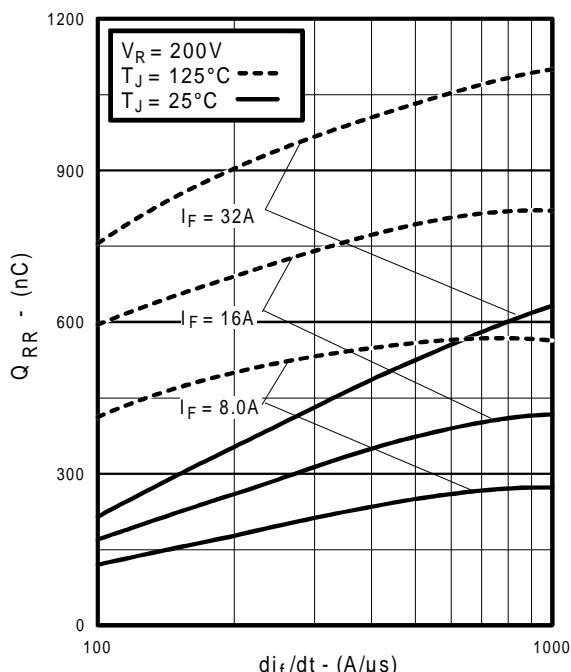


Fig. 16 - Typical Stored Charge vs. di_f/dt

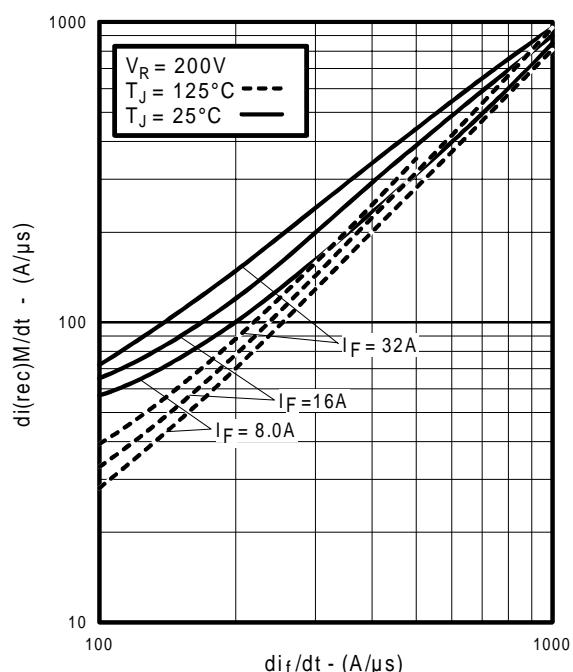


Fig. 17 - Typical $di_{(rec)M}/dt$ vs. di_f/dt

IRG4PF50WD

International
IR Rectifier

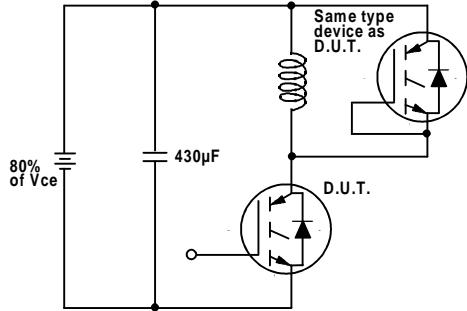


Fig. 18a - Test Circuit for Measurement of
 I_{LM} , E_{on} , $E_{off(diode)}$, t_{rr} , Q_{rr} , I_{rr} , $t_{d(on)}$, t_r , $t_{d(off)}$, t_f

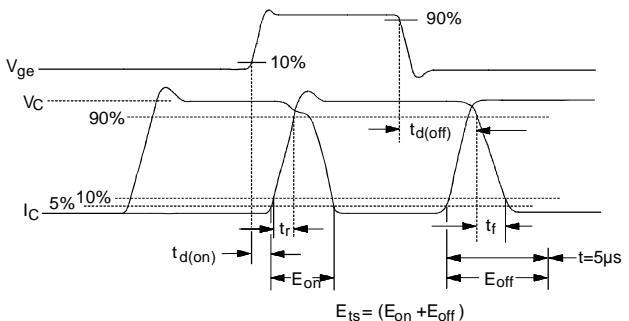


Fig. 18b - Test Waveforms for Circuit of Fig. 18a, Defining
 E_{off} , $t_{d(off)}$, t_f

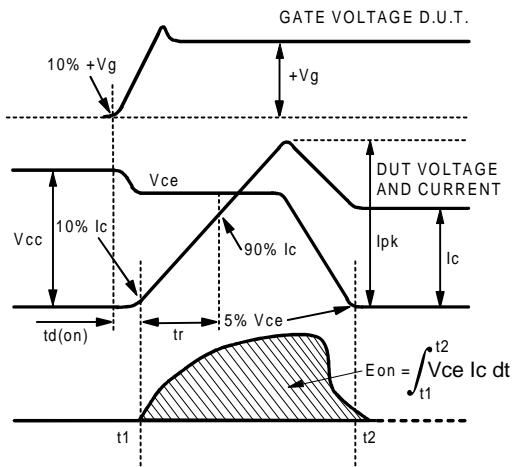


Fig. 18c - Test Waveforms for Circuit of Fig. 18a,
Defining E_{on} , $t_{d(on)}$, t_r

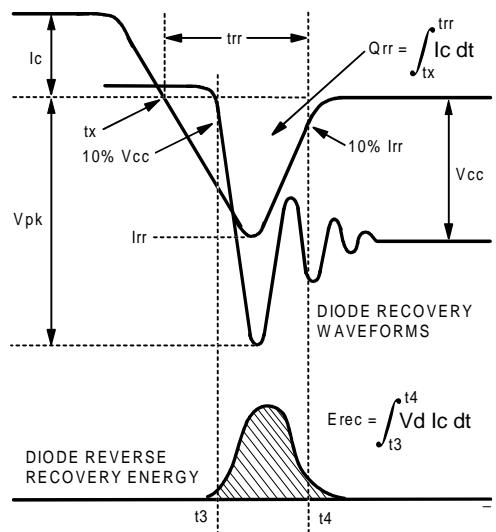


Fig. 18d - Test Waveforms for Circuit of Fig. 18a,
Defining E_{rec} , t_{rr} , Q_{rr} , I_{rr}

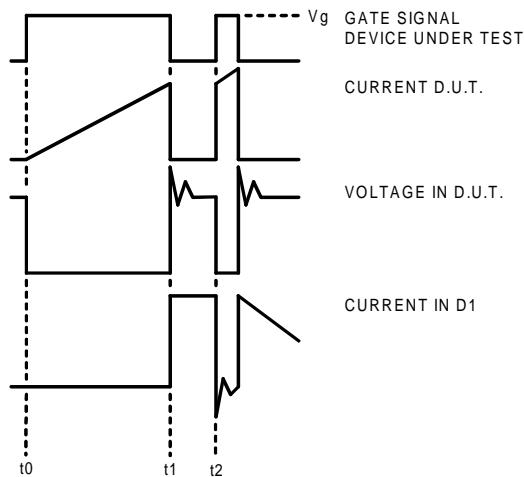


Figure 18e. Macro Waveforms for Figure 18a's Test Circuit

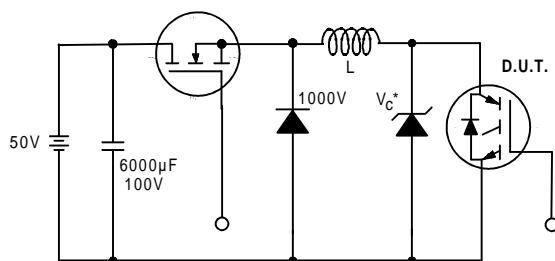


Figure 19. Clamped Inductive Load Test Circuit

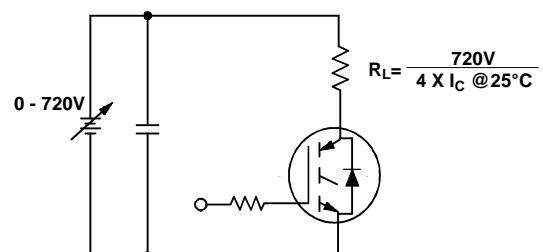


Figure 20. Pulsed Collector Current Test Circuit

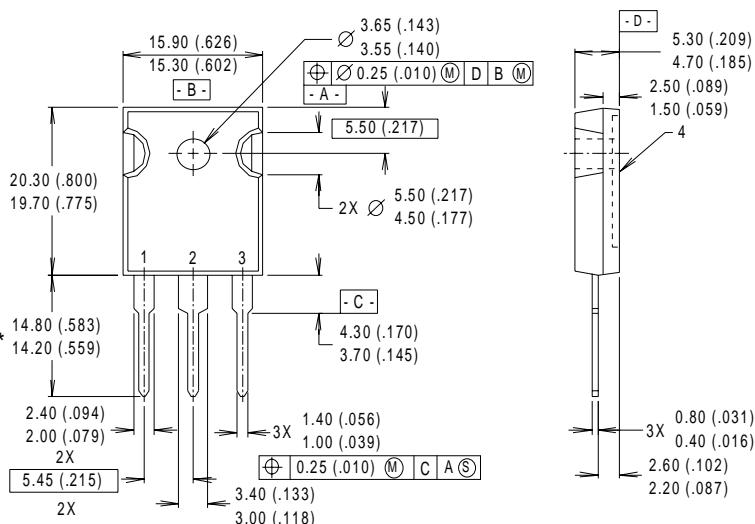
IRG4PF50WD

International
IR Rectifier

Notes:

- ① Repetitive rating: $V_{GE}=20V$; pulse width limited by maximum junction temperature (figure 20)
- ② $V_{CC}=80\% (V_{CES})$, $V_{GE}=20V$, $L=10\mu H$, $R_G=5.0\Omega$ (figure 19)
- ③ Pulse width $\leq 80\mu s$; duty factor $\leq 0.1\%$.
- ④ Pulse width $5.0\mu s$, single shot.

Case Outline and Dimensions — TO-247AC



NOTES:
1 DIMENSIONS & TOLERANCING
PER ANSI Y14.5M, 1982.
2 CONTROLLING DIMENSION : INCH.
3 DIMENSIONS ARE SHOWN
MILLIMETERS (INCHES).
4 CONFORMS TO JEDEC OUTLINE
TO-247AC.

LEAD ASSIGNMENTS
1 - GATE
2 - COLLECTOR
3 - Emitter
4 - COLLECTOR

* LONGER LEADED (20mm)
VERSION AVAILABLE (TO-247AD)
TO ORDER ADD "-E" SUFFIX
TO PART NUMBER

CONFORMS TO JEDEC OUTLINE TO-247AC (TO-3P)

Dimensions in Millimeters and (Inches)

International
IR Rectifier

WORLD HEADQUARTERS: 233 Kansas St., El Segundo, California 90245, Tel: (310) 322 3331

IR GREAT BRITAIN: Hurst Green, Oxted, Surrey RH8 9BB, UK Tel: ++ 44 1883 732020

IR CANADA: 15 Lincoln Court, Brampton, Ontario L6T3Z2, Tel: (905) 453 2200

IR GERMANY: Saalburgstrasse 157, 61350 Bad Homburg Tel: ++ 49 6172 96590

IR ITALY: Via Liguria 49, 10071 Borgaro, Torino Tel: ++ 39 11 451 0111

IR FAR EAST: K&H Bldg., 2F, 30-4 Nishi-Ikebukuro 3-Chome, Toshima-Ku, Tokyo Japan 171 Tel: 81 3 3983 0086

IR SOUTHEAST ASIA: 315 Outram Road, #10-02 Tan Boon Liat Building, Singapore 0316 Tel: 65 221 8371

IR TAIWAN: 16 Fl. Suite D. 207, Sec. 2, Tun Haw South Road, Taipei, 10673, Taiwan Tel: 886-2-2377-9936